1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD123W small and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Average forward current: I_{F(AV)} ≤ 1 A
- Reverse voltage: V_R ≤ 60 V
- Extremely low leakage current
- Low forward voltage
- · High power capability due to clip-bonding technology
- Small and flat lead SMD plastic package
- · Qualified according to AEC-Q101 and recommended for use in automotive applications
- High temperature T_i ≤ 175 °C
- Suitable for both reflow and wave soldering

3. Applications

- · Low voltage rectification
- · High efficiency DC-to-DC conversion
- Switch mode power supply
- Reverse polarity protection

4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--------------------|-------------------------|--|-----|-----|-----|------|
| I _{F(AV)} | average forward current | δ = 0.5; f = 20 kHz; square wave; T _{sp} \leq 170 °C | - | - | 1 | А |
| V_R | reverse voltage | T _j = 25 °C | - | - | 60 | V |
| V _F | forward voltage | I _F = 1 A; T _j = 25 °C | - | 605 | 660 | mV |
| I _R | reverse current | V_R = 60 V; $t_p \le 300 \mu s$; δ ≤ 0.02; T_j = 25 °C; pulsed | - | 90 | 300 | nA |



5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-------------|--------------------|-------------------------------|
| 1 | K | cathode[1] | 1 2 | К _[< -А |
| 2 | А | anode | CFP3 (SOD123W) | sym001 |

^[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

| Type number | Package | | | | | |
|---------------|---------|--|---------|--|--|--|
| | Name | Description | Version | | | |
| PMEG6010ELR-Q | CFP3 | plastic, surface mounted package; 2 terminals; 2.6 mm x 1.7 mm x 1 mm body | SOD123W | | | |

7. Marking

Table 4. Marking codes

| Type number | Marking code |
|---------------|--------------|
| PMEG6010ELR-Q | K1 |

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|--------------------|-------------------------------------|---|-----|-----|------|------|
| V _R | reverse voltage | T _j = 25 °C | | - | 60 | V |
| I _F | forward current | δ = 1; T _{sp} = 165 °C | | - | 1.41 | А |
| I _{F(AV)} | average forward current | δ = 0.5; f = 20 kHz; square wave; $T_{sp} \le$ 170 °C | | - | 1 | А |
| | | δ = 0.5; f = 20 kHz; square wave; $T_{amb} \le$ 140 °C | [1] | - | 1 | Α |
| I _{FSM} | non-repetitive peak forward current | t_p = 8 ms; square wave; $T_{j(init)}$ = 25 °C | | - | 50 | Α |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C | [2] | - | 680 | mW |
| | | | [3] | - | 1.15 | W |
| | | | [1] | - | 2.14 | W |
| Tj | junction temperature | | | - | 175 | °C |
| T _{amb} | ambient temperature | | | -55 | 175 | °C |
| T _{stg} | storage temperature | | | -65 | 175 | °C |

^{1]} Device mounted on a ceramic PCB, Al₂O₃, standard footprint.

^[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|-----------------------|--|-------------|---------|-----|-----|-----|------|
| R _{th(j-a)} | thermal resistance from | in free air | [1] [2] | - | - | 220 | K/W |
| junction to an | junction to ambient | | [1] [3] | - | - | 130 | K/W |
| | | | [1] [4] | - | - | 70 | K/W |
| R _{th(j-sp)} | thermal resistance from junction to solder point | | [5] | - | - | 18 | K/W |

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.
- [5] Soldering point of cathode tab.

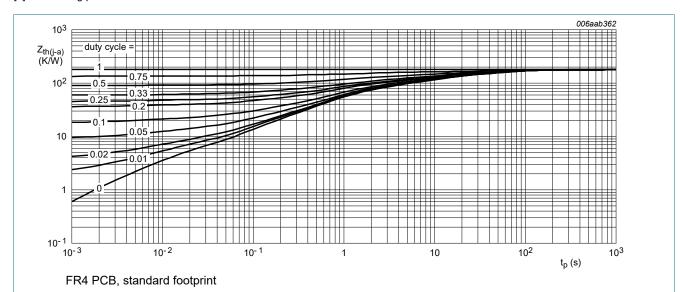


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

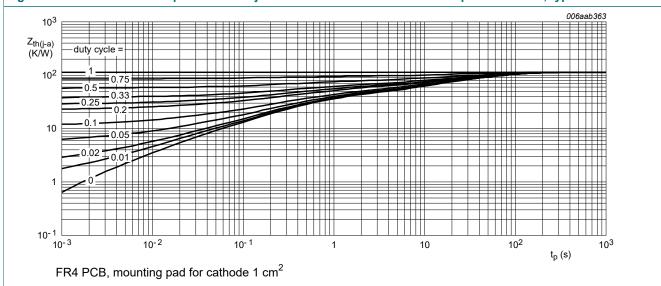
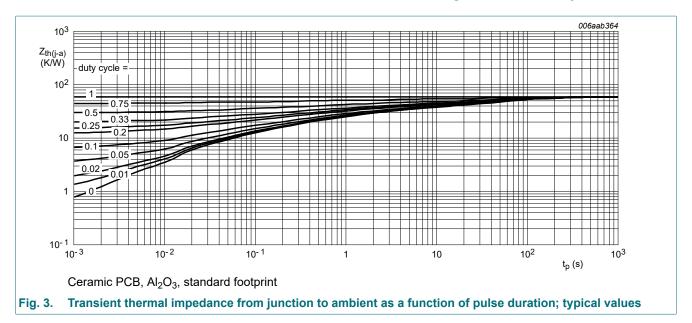


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



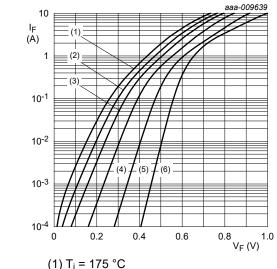
10. Characteristics

Table 7. Characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------|-------------------------------|---|-----|-----|-----|------|
| $V_{(BR)R}$ | reverse breakdown voltage | I _R = 1 mA; T _j = 25 °C | 60 | - | - | V |
| V _F | forward voltage | I _F = 0.1 A; T _j = 25 °C | - | 475 | 540 | mV |
| | | I _F = 0.5 A; T _j = 25 °C | - | 550 | 605 | mV |
| | | I _F = 0.7 A; T _j = 25 °C | - | 575 | 625 | mV |
| | | I _F = 1 A; T _j = 25 °C | - | 605 | 660 | mV |
| I _R | reverse current | V_R = 5 V; $t_p \le 300 \text{ μs}$; $\delta \le 0.02$; T_j = 25 °C; pulsed | - | 5 | - | nA |
| | | V_R = 10 V; $t_p \le 300 \mu s$; δ ≤ 0.02; T_j = 25 °C; pulsed | - | 6 | - | nA |
| | | $V_R = 40 \text{ V}; t_p \le 300 \text{ µs}; \delta \le 0.02;$ $T_j = 25 ^{\circ}\text{C}; \text{ pulsed}$ | - | 25 | 50 | nA |
| | | $V_R = 60 \text{ V}; t_p \le 300 \text{ µs}; \delta \le 0.02;$ $T_j = 25 ^{\circ}\text{C}; \text{ pulsed}$ | - | 90 | 300 | nA |
| | | $V_R = 10 \text{ V}; t_p \le 300 \mu\text{s}; \delta \le 0.02;$ $T_j = 125 ^\circ\text{C}; \text{ pulsed}$ | - | 25 | - | μΑ |
| | | $V_R = 60 \text{ V}; t_p \le 300 \mu\text{s}; \delta \le 0.02;$ $T_j = 125 ^\circ\text{C}; \text{ pulsed}$ | - | 120 | - | μΑ |
| C _d | diode capacitance | V _R = 1 V; f = 1 MHz; T _j = 25 °C | - | 110 | - | pF |
| | | V _R = 4 V; f = 1 MHz; T _j = 25 °C | - | 65 | - | pF |
| | | V _R = 10 V; f = 1 MHz; T _j = 25 °C | - | 45 | - | pF |
| t _{rr} | reverse recovery time | $I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 \text{ °C}$ | - | 4.5 | - | ns |
| V_{FRM} | peak forward recovery voltage | $I_F = 0.5 \text{ A}; dI_F/dt = 20 \text{ A/}\mu\text{s}; T_j = 25 ^{\circ}\text{C}$ | - | 580 | - | mV |

aaa-009642

60 V, 1 A low leakage current Schottky barrier rectifier



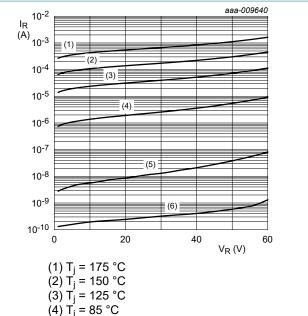
(2) $T_i = 150 °C$

(3) $T_i = 125 °C$

 $(4) T_i = 85 ^{\circ}C$

 $(5) T_i = 25 ^{\circ}C$ (6) $T_i = -40 \, ^{\circ}\text{C}$

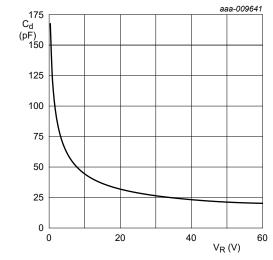
Fig. 4. Forward current as a function of forward voltage; typical values



 $(5) T_i = 25 ^{\circ}C$ (6) $T_i = -40 \,^{\circ}\text{C}$

8.0

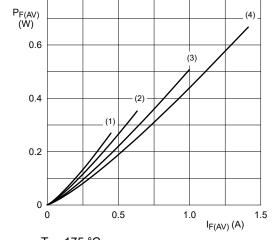
Fig. 5. Reverse current as a function of reverse voltage; typical values



Diode capacitance as a function of reverse

 $f = 1 \text{ MHz}; T_{amb} = 25 \text{ °C}$

voltage; typical values



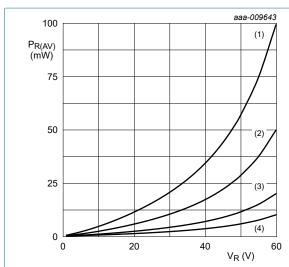
T_i = 175 °C $(1) \delta = 0.1$

 $(2) \delta = 0.2$

 $(3) \delta = 0.5$ $(4) \delta = 1$

Fig. 7. Average forward power dissipation as a function of average forward current; typical values

Fig. 6.



 $T_j = 150 \, ^{\circ}C$

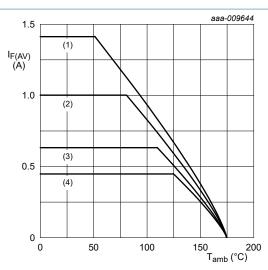
 $(1) \delta = 1$

 $(2) \delta = 0.5$

 $(3) \delta = 0.2$

 $(4) \delta = 0.1$

Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

T_i = 175 °C

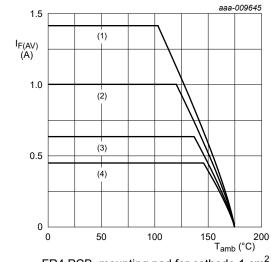
 $(1) \delta = 1 (DC)$

 $(2) \delta = 0.5$; f = 20 kHz

 $(3) \delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm²

 $T_i = 175 \,{}^{\circ}\text{C}$

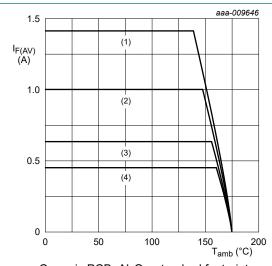
 $(1) \delta = 1 (DC)$

 $(2) \delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 10. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al₂O₃, standard footprint

 $T_i = 175 \,{}^{\circ}\text{C}$

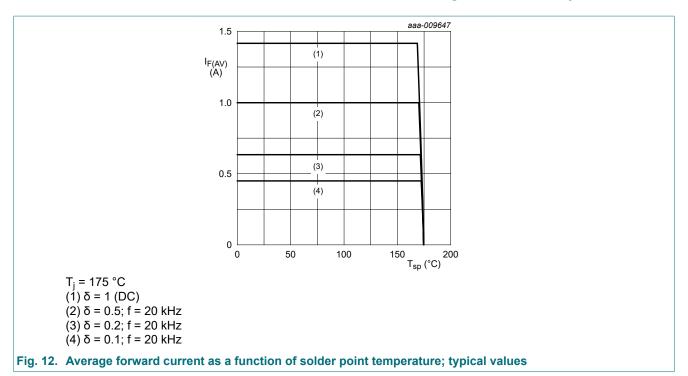
 $(1) \delta = 1 (DC)$

 $(2) \delta = 0.5$; f = 20 kHz

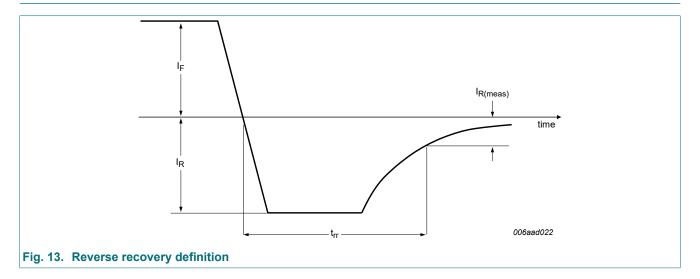
(3) $\delta = 0.2$; f = 20 kHz

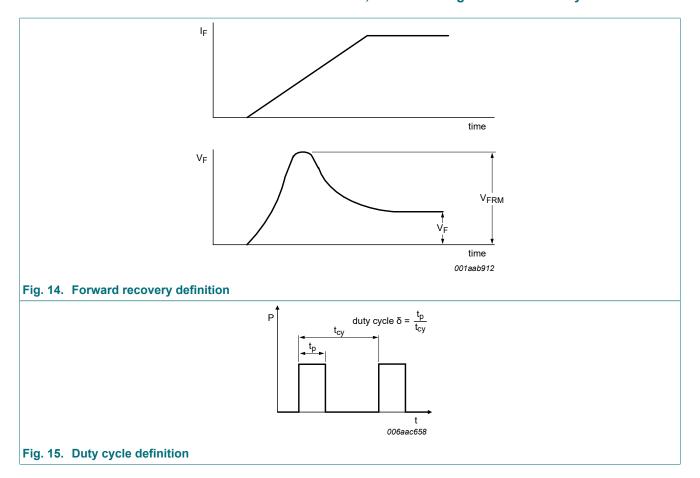
(4) $\delta = 0.1$; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



11. Test information



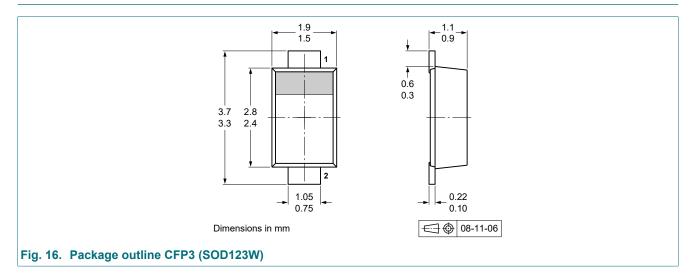


The current ratings for the typical waveforms are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current, $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

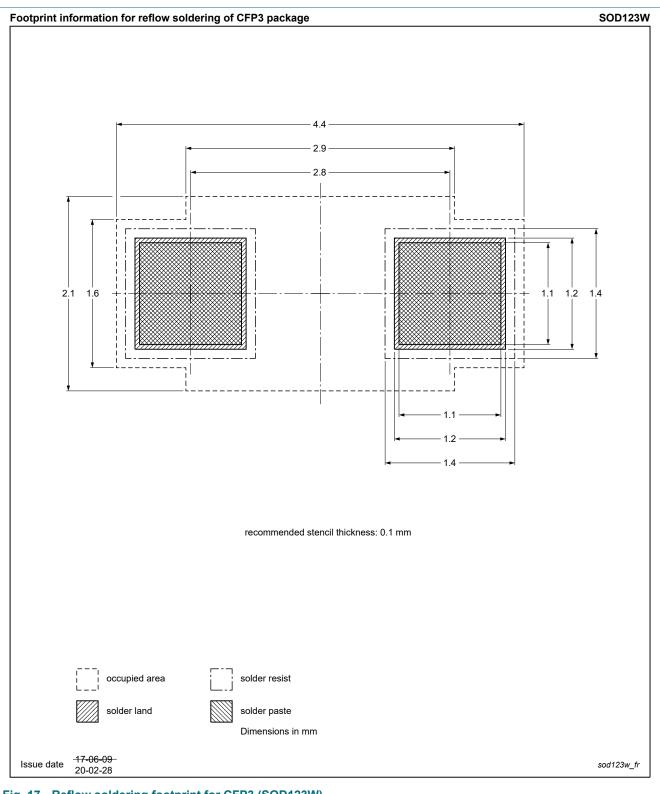
Quality information

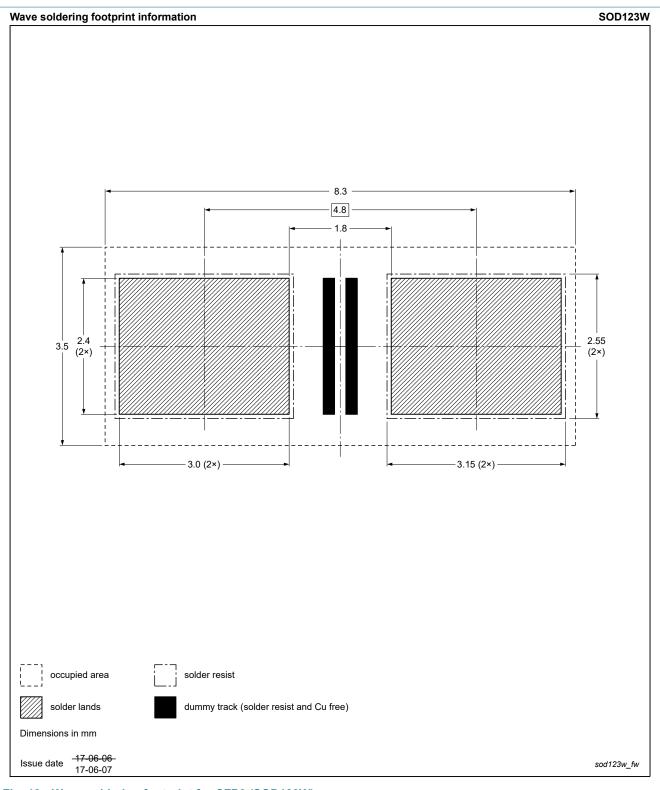
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



13. Soldering





14. Revision history

Table 8. Revision history

| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes |
|-------------------|--------------|--------------------|---------------|------------|
| PMEG6010ELR-Q v.1 | 20210511 | Product data sheet | - | - |

15. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|-----------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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